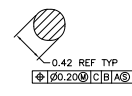
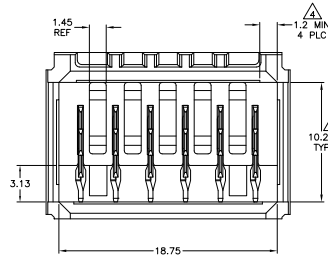
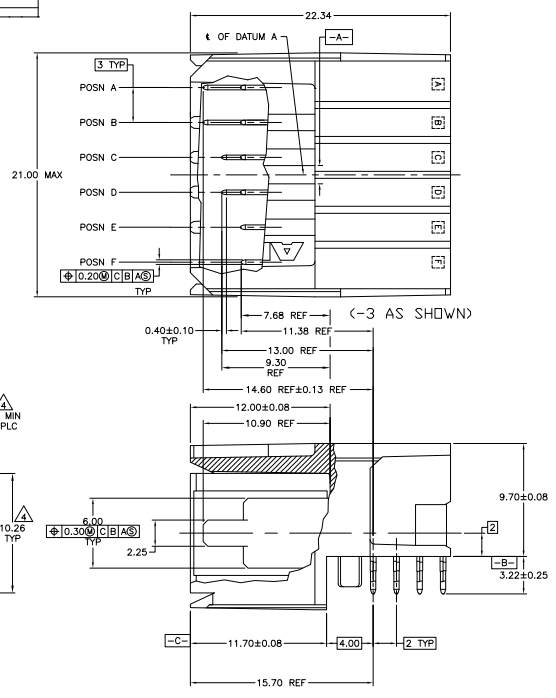
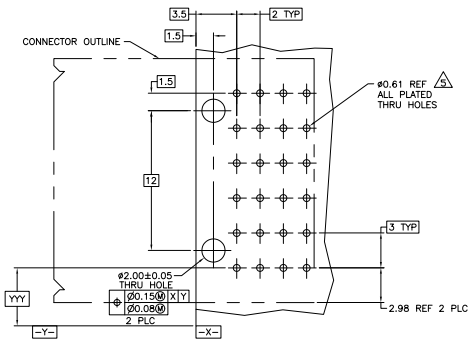
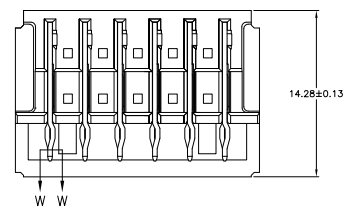


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REV	DATE	DESCRIPTION	BY	CHK	APP
AD 00		REVISED PER EDD-11-004835			



SECTION W-W
 SCALE 40:1



RECOMMENDED PCB HOLE LAYOUT

- △ MATERIAL: HOUSING: POLYESTER. COLOR: GRAY. UL 94V-0. CONTACT: PHOSPHOR BRONZE.
- △ FINISH: CONTACT MATING AREA: 1.27µm MIN GOLD OR 0.08µm MIN GOLD OVER 0.76µm MIN PALLADIUM-NICKEL ACTION PIN AREA: 0.5µm MIN TIN PLATE, ALL OVER 1.27µm MIN NICKEL UNDERPLATE.
- △ FINISH: CONTACT LUBRICATION WITH BELLCORE APPROVED LUBRICANT. TECHNICAL REFERENCE: GR-1217-CORE, ISSUE 1, NOVEMBER 1995.
- △ THE 10.26±0.13 DIMENSION APPLIES IN THIS AREA.
- △ REFERENCE APPLICATION SPEC 114-1103 FOR RECOMMENDED PLATED THRU HOLE DIAMETER AND PLATING THICKNESS.
- 6. CURRENT RATING 10A/CONTACT PER PRODUCT SPEC 108-1651.

FINISH	A,B,C,D,E,F	POSITIONS LOADED WITH 10.90 CONTACTS	POSITIONS LOADED WITH 9.30 CONTACTS	POSITIONS LOADED WITH 7.68 CONTACTS	NO OF PARTS	PART NUMBER
△	-	A,B,C,D	E,F	-	6	5646956-6
△	A,B	D,E,F	C	-	6	5646956-5
△	A,D,E,F	B	C	-	6	5646956-4
△	A,B	C,D	E,F	-	6	5646956-3
△	A,F	B,C,D,E	-	-	6	5646956-2
△	A,B,C,D,E,F	-	-	-	6	5646956-1

THIS DRAWING IS A CONTROLLED DOCUMENT.	REVISED PER EDD-11-004835	DATE	11/19/11	BY	RM	APP	HMR
INFORMATION	TE CONNECTIVITY	ASSEMBLY, RIGHT ANGLE HEADER, W/ RETENTION PEGS, UNIVERSAL POWER MODULE	SIZE	DATE	ISSUE	NO	REV
DATE	10/07/09	ISSUE	6.1	NO	1	REV	E1